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May 2014

FXL4245 Low-Voltage, Dual-Supply, 8-Bit, Signal Translator with Configurable Voltage Supplies, Signal Levels, and 3-State Outputs

Features

- Bi-Directional Interface between Two Levels from 1.1 V to 3.6 V
- Fully Configurable, Inputs Track V_{CC} Level
- Non-Preferential Power-up; Either V_{CC} May Be Powered-up First
- Outputs Remain in 3-State until Active V_{CC} Level is Reached
- Outputs Switch to 3-State if Either V_{CC} is at GND
- Power-Off Protection
- Control Inputs (T/R, OE) Levels are Referenced To V_{CCA} Voltage
- Packaged in 24-Pin MLP
- ESD Protection Exceeds:
 - 4 kV Human Body Model (per JESD22-A114 & Mil Std 883e 3015.7)
 - 8 kV Human Body Model I/O to GND (per JESD22-A114 & Mil Std 883e 3015.7)
 - 1 kV Charge Device Model (per ESD STM 5.3)
 - 200 V Machine Model (per JESD22-A115 & ESD STM5.2)

Description

The FXL4245 is a configurable dual-voltage-supply translator designed for bi-directional voltage translation of signals between two voltage levels. The device allows translation between voltages as high as 3.6 V to as low as 1.1 V. The A port tracks the $V_{\rm CCA}$ level and the B port tracks the $V_{\rm CCB}$ level. Both ports are designed to accept supply voltage levels from 1.1 V to 3.6 V. This allows for bi-directional voltage translation over a variety of voltage levels: 1.2 V, 1.5 V, 1.8 V, 2.5 V, and 3.3 V.

The device remains in 3-state until both $V_{\rm CC}s$ reach active levels, allowing either $V_{\rm CC}$ to be powered-up first. The device also contains power-down control circuits that place the device in 3-state if either $V_{\rm CC}$ is removed.

The Transmit/Receive (T/\overline{R}) input determines the direction of data flow through the device. The \overline{OE} input, when HIGH, disables both the A and B ports by placing them in a 3-state condition. The FXL4245 is designed with the control pins (T/\overline{R}) and OE supplied by V_{CCA} .

Ordering Information

Part Number	Package	Packing Method
FXL4245MPX	24-Pin Molded Leadless Package (MLP), JEDEC MO-220, 3.5 x 4.5 mm	Tape and Reel

Pin Configuration

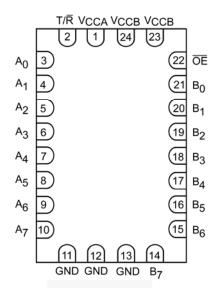


Figure 1. Pin Configuration (Top Through View)

Pin Definitions

Pin #	Name	Description
1	V _{CCA}	Side-A Power Supply
2	T/R	Transmit / Receive Input
3, 4, 5, 6, 7, 8, 9, 10	A ₀ , A ₁ , A ₂ , A ₃ , A ₄ , A ₅ , A ₆ , A ₇	Side-A Inputs or 3-State Outputs
11, 12, 13	GND	Ground
14, 15, 16, 17, 18, 19, 20, 21	B ₇ , B ₆ , B ₅ , B ₄ , B ₃ , B ₂ , B ₁ , B ₀	Side-B Inputs or 3-State Outputs
22	ŌĒ	Output Enable Input
23, 24	V _{CCB}	Side-B Power Supply
DAP	No Connect	No Connect

Truth Table

Inp	Inputs								
ŌĒ	T/R	Description							
LOW Voltage Level	LOW Voltage Level	Bus B Data to Bus A							
LOW Voltage Level	HIGH Voltage Level	Bus A Data to Bus B							
HIGH Voltage Level	Don't Care	3-State							

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Conditions		Min.	Max.	Unit
V _{CCA}	Cupply Voltage			-0.5	4.6	V
V _{CCB}	- Supply Voltage			-0.5	4.6	V
		I/O Port A		-0.5	4.6	
V_{I}	DC Input Voltage	I/O Port B		-0.5	4.6	V
		Control Inputs (T/R, OE)		-0.5	4.6	
		Output 3-State		-0.5	4.6	
Vo	Output Voltage ⁽¹⁾	Output Active (A _n)		-0.5 to V _{CCA}	0.5	V
		Output Active (B _n)		-0.5 to V _{CCB}	0.5	
I _{IK}	DC Input Diode Current	V _I < 0 V			-50	mA
	DC Output Diode Current	V _O < 0 V			-50	mA
I _{OK}	DC Output Diode Current	$V_O > V_{CC}$			50	IIIA
I _{OH} /I _{OL}	DC Output Source/Sink Co	urrent			±50	mA
I _{cc}	DC V _{CC} or Ground Current	per Supply Pin			±100	mA
T _{STG}	Storage Temperature Ran	ge		-65	+150	°C
		Human Body Model,			4	
ESD	Electrostatic Discharge	JESD22-A114, Mil Std 883e 3015.7	I/O to GND		8	kV
ESD	O 1.333	Charged Device Model, JESD22-C10	1,STM 5.3		1	
		Machine Model, JESD22-A115,STM	5.2		200	V

Note:

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter		Conditions	Min.	Max.	Unit
V _{cc}	Power Supply	Operating \	V _{CCA} or V _{CCB}	1.1	3.6	V
		Port A		0	3.6	
V_{I}	Input Voltage	Port B		0	3.6	V
		Control Inp	uts (T/R, ŌE)	0	V_{CCA}	Γ
			3.0 V to 3.6 V		±24	
			2.3 V to 2.7 V		±18	
I _{OH} /I _{OL}	Output Current	V_{CC0}	1.65 V to 1.95 V		±6	mA
			1.40 V to 1.65 V		±2	
			1.1 V to 1.4 V		±0.5	
T _A	Operating Temperature, Free Air	•	•	-40	+85	°C
ΔV/Δt	Minimum Input Edge Rate	V _{CCA/B} =1.1	V to 3.6 V		10	ns/V

Note:

2. All unused inputs must be held at V_{CCI} or GND.

^{1.} I/O absolute maximum ratings must be observed.

Electrical Characteristics

Symbol	Parameter	Conditions	V _{CCI} (V)	V _{cco} (V)	Min.	Max.	Units
			2.70 to 3.60		2.0		
			2.30 to 2.70		1.6		
		Data Inputs A _n , B _n	1.65 to 2.30	1.1 to 3.6	0.65 x V _{CCI}		
			1.40 to 1.65		0.65 x V _{CCI}		
.,	(3)		1.10 to 1.40		0.9 x V _{CCI}		.,
V_{IH}	HIGH Level Input ⁽³⁾	2.70 to 3.	2.70 to 3.6		2.0		V
			2.30 to 2.70		1.6		
		Control Pins OE, T/R	1.65 to 2.30	1.1 to 3.6	0.65 x V _{CCA}		
		(Referenced to V _{CCA})	1.40 to 1.65		0.65 x V _{CCA}		
			1.10 to 1.40		0.9 x V _{CCA}		
			2.70 to 3.60			0.8	
			2.30 to 2.70			0.7	
		Data Inputs A _n , B _n	1.65 to 2.30	1.1 to 3.6		0.35 x V _{CCI}	
			1.40 to 1.65			0.35 x V _{CCI}	
	(3)		1.10 to 1.40	\		0.10 x V _{CCI}	
V_{IL}	LOW Level Input ⁽³⁾		2.70 to 3.60			0.8	V
			2.30 to 2.70			0.7	
		Control Pins /OE, T/R	1.65 to 2.30	1.1 to 3.6		0.35 x V _{CCI}	
		(Referenced to V _{CCA})	1.40 to 1.65	_		0.35 x V _{CCI}	
			1.10 to 1.40			0.10 x V _{CCI}	
		Ι _{ΟΗ} = -100 μΑ	1.1 to 3.6	1.1 to 3.6	V _{CC0} - 0.2		
		I _{OH} = -12 mA	2.7	2.7	2.2		
		I _{OH} = -18 mA	3.0	3.0	2.4		
		I _{OH} = -24 mA	3.0	3.0	2.2		
	(4)	I _{OH} = -6 mA	2.3	2.3	2.0		
V_{OH}	HIGH Level Output ⁽⁴⁾	I _{OH} = -12 mA	2.3	2.3	1.8		V
		I _{OH} = -18 mA	2.3	2.3	1.7		
		I _{OH} = -6 mA	1.65	1.65	1.25		
		I _{OH} = -2 mA	1.4	1.4	1.05		
		I _{OH} = -0.5 mA	1.1	1.1	0.75 x V _{CC0}		
		I _{OL} = 100 μA	1.1 to 3.6	1.1 to 3.6	550	0.2	
		I _{OL} = 12 mA	2.7	2.7		0.4	
		I _{OL} = 18 mA	3.0	3.0		0.4	
		I _{OL} = 24 mA	3.0	3.0		0.55	
V_{OL}	LOW Level Output ⁽⁴⁾	I _{OL} = 12 mA	2.3	2.3		0.4	V
JL		I _{OL} = 18 mA	2.3	2.3	12/	0.6	
		$I_{OL} = 6 \text{ mA}$	1.65	1.65		0.3	
		$I_{OL} = 2 \text{ mA}$	1.4	1.4		0.35	
	I _C	OL					

Continued on the following page...

Electrical Characteristics

Symbol	Parameter	Conditions	V _{CCI} (V)	V _{cco} (V)	Min.	Max.	Units
Ιι	Input Leakage Current, Control Pins	V _I =V _{CCA} or GND	1.1 to 3.6	3.6		±1.0	μΑ
	Power Off Leakage	A _n , V _i or V _O =0 V to 3.6 V	0	3.6		±10	
I _{OFF}	Current	B _n , V _I or V _O =0 V to 3.6 V	3.6	0		±10	μΑ
	3-State Output	A_n , B_n , $/OE=V_{IH}$	3.6	3.6		±10	
loz	Leakage $(0 \le V_0 \le 3.6 \text{ V},$	B _n , /OE= Don't Care ⁽⁵⁾	0	3.6		±10	μΑ
	$V_{I}=V_{IH} \text{ or } V_{IL}$	A _n , /OE= Don't Care ⁽⁵⁾	3.6	0		±10	
I _{CCA/B}		V V as CND: L O	1.1 to 3.6	1.1 to 3.6		20	
I _{ccz}		V _I =V _{CCI} or GND; I _O =0	1.1 to 3.6	1.1 to 3.6		20	
	Quiescent Supply	V V or CND: L O	0	1.1 to 3.6		-10	
I _{CCA}	Current ⁽⁶⁾	$V_I = V_{CCA}$ or GND; $I_O = 0$	1.1 to 3.6	0		10	μA
		V V CND-1 0	1.1 to 3.6	0		-10	
I _{CCB}		$V_I = V_{CCB}$ or GND; $I_O = 0$	0	1.1 to 3.6		10	
Δl _{CCA/B}	Increase in I _{CC} per Input; Other Inputs at V _{CC} or GND	V _{IH} =3.0	3.6	3.6		500	μΑ

- V_{CCI} = the V_{CC} associated with the data input under test. V_{CCO} = the V_{CC} associated with the output under test. Don't care = any valid logic level. Reflects current per supply, V_{CCA} or V_{CCB} .

AC Electrical Characteristics

V_{CCA}=3.0 V to 3.6 V

					,	T _A = -40	to +85°C	;				
Symbol	Parameter		=3.0 V 5.6 V		V _{CCB} =2.3 V to 2.7 V		V _{CCB} =1.65 V to 1.95 V		=1.4 V .6 V	V _{CCB} =1.1 V to 1.3 V		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
	Propagation Delay A to B	0.2	3.5	0.3	3.9	0.5	5.4	0.6	6.8	1.4	22.0	200
t _{PLH} , t _{PHL}	Propagation Delay B to A	0.2	3.5	0.2	3.8	0.3	4.0	0.5	4.3	0.8	13.0	ns
	Output Enable /OE to B	0.5	4.0	0.7	4.4	1.0	5.9	1.0	6.4	1.5	17.0	200
t _{PZH,} t _{PZL}	Output Enable /OE to A	0.5	4.0	0.5	4.0	0.5	4.0	0.5	4.0	0.5	4.0	ns
	Output Disable /OE to B	0.2	3.8	0.2	4.0	0.7	4.8	1.5	6.2	2.0	17.0	20
t _{PHZ} , t _{PLZ}	Output Disable /OE to A	0.2	3.7	0.2	3.7	0.2	3.7	0.2	3.7	0.2	3.7	ns

V_{CCA}=2.3 V to 2.7 V

					•	T _A = -40	to +85°C	;				
Symbol	Parameter		=3.0 V 5.6 V		V _{CCB} =2.3 V to 2.7 V		V _{CCB} =1.65 V to 1.95 V		=1.4 V .6 V	V _{CCB} =1.1 V to 1.3 V		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
	Propagation Delay A to B	0.2	3.8	0.4	4.2	0.5	5.6	0.8	6.9	1.4	22.0	20
t _{PLH,} t _{PHL}	Propagation Delay B to A	0.3	3.9	0.4	4.2	0.5	4.5	0.5	4.8	1.0	7.0 ns	ns
	Output Enable /OE to B	0.6	4.2	0.8	4.6	1.0	6.0	1.0	6.8	1.5	17.0	ns
t _{PZH,} t _{PZL}	Output Enable /OE to A	0.6	4.5	0.6	4.5	0.6	4.5	0.6	4.5	0.6	4.5	115
	Output Disable /OE to B	0.2	4.1	0.2	4.3	0.7	4.8	1.5	6.7	2.0	17.0	20
t _{PHZ} , t _{PLZ}	Output Disable /OE to A	0.2	4.0	0.2	4.0	0.2	4.0	0.2	4.0	0.2	4.0	ns

V_{CCA}=1.65 V to 1.95 V

					•	T _A = -40	to +85°C	;				
Symbol	Parameter	V _{CCB} =3.0 V to 3.6 V		V _{CCB} =2.3 V to 2.7 V		V _{CCB} =1.65 V to 1.95 V		V _{CCB} =1.4 V to 1.6 V		V _{CCB} =1.1 V to 1.3 V		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
	Propagation Delay A to B	0.3	4.0	0.5	4.5	0.8	5.7	0.9	7.1	1.5	22.0	200
t _{PLH,} t _{PHL}	Propagation Delay B to A	0.5	5.4	0.5	5.6	0.8	5.7	1.0	6.0	1.2	8.0	ns
	Output Enable /OE to B	0.6	5.2	0.8	5.4	1.2	6.9	1.2	7.2	1.5	18.0	- ns
$t_{PZH,}$ t_{PZL}	Output Enable /OE to A	1.0	6.7	1.0	6.7	1.0	6.7	1.0	6.7	1.0	6.7	
	Output Disable /OE to B	0.2	5.1	0.2	5.2	0.8	5.2	1.5	7.0	2.0	17.0	20
t _{PHZ} , t _{PLZ}	Output Disable /OE to A	0.5	5.0	0.5	5.0	0.5	5.0	0.5	5.0	0.5	5.0	ns

AC Electrical Characteristics (Continued)

V_{CCA}=1.4 V to 1.6 V

V CCA-11-4						T _A = -40	to +85°C	;				
Symbol	Parameter	V _{CCB} =3.0 V to 3.6 V		V _{CCB} =2.3 V to 2.7 V		V _{CCB} =1.65 V to 1.95 V		V _{CCB} =1.4 V to 1.6 V		V _{CCB} =1.1 V to 1.3 V		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
	Propagation Delay A to B	0.5	4.3	0.5	4.8	1.0	6.0	1.0	7.3	1.5	22.0	20
t _{PLH,} t _{PHL}	Propagation Delay B to A	0.6	6.8	0.8	6.9	0.9	7.1	1.0	7.3	1.3	9.5	ns
	Output Enable /OE to B	1.1	7.5	1.1	7.6	1.3	7.7	1.4	7.9	2.0	20.0	ns
t _{PZH,} t _{PZL}	Output Enable /OE to A	1.0	7.5	1.0	7.5	1.0	7.5	1.0	7.5	1.0	7.5	115
	Output Disable /OE to B	0.4	6.1	0.4	6.2	0.9	6.2	1.5	7.5	2.0	18.0	22
t _{PHZ} , t _{PLZ}	Output Disable /OE to A	1.0	6.0	1.0	6.0	1.0	6.0	1.0	6.0	1.0	6.0	ns

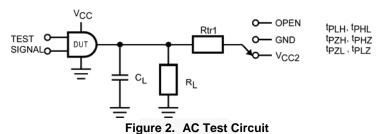
V_{CCA}=1.1 V to 1.3 V

- CCA	/					T _A = -40	to +85°C	;				
Symbol	Parameter	V _{CCB} =3.0 V to 3.6 V		V _{CCB} =2.3 V to 2.7 V		V _{CCB} =1.65 V to 1.95 V		V _{CCB} =1.4 V to 1.6 V		V _{CCB} =1.1 V to 1.3 V		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
	Propagation Delay A to B	0.8	13.0	1.0	7.0	1.2	8.0	1.3	9.5	2.0	24.0	
t _{PLH,} t _{PHL}	Propagation Delay B to A	1.4	22.0	1.4	22.0	1.5	22.0	1.5	22.0	2.0	24.0	ns
	Output Enable /OE to B	1.0	12.0	1.0	9.0	2.0	10.0	2.0	11.0	2.0	24.0	200
t _{PZH,} t _{PZL}	Output Enable /OE to A	2.0	22.0	2.0	22.0	2.0	22.0	2.0	22.0	2.0	22.0	ns
	Output Disable /OE to B	1.0	15.0	0.7	7.0	1.0	8.0	2.0	10.0	2.0	20.0	20
t _{PHZ} , t _{PLZ}	Output Disable /OE to A	2.0	15.0	2.0	12.0	2.0	12.0	2.0	12.0	2.0	12.0	ns

Capacitance

Symbol	Parameter	Conditions	T _A =+25°C	Units
Symbol		Conditions	Typical	
C _{IN}	Input Capacitance	V _{CCA} =V _{CCB} =0 V, V _I =0 V or V _{CCA/B}	4	pF
C _{I/O}	Input/Output Capacitance	$V_{CCA}=V_{CCB}=3.3 \text{ V}, V_I=0 \text{ V or } V_{CCA/B}$	5	pF
C _{PD}	Power Dissipation Capacitance	$V_{CCA}=V_{CCB}=3.3 \text{ V}, V_{I}=0 \text{ V or } V_{CC}, f=10 \text{ MHz}$	20	pF

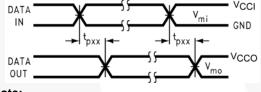
AC Loadings and Waveforms

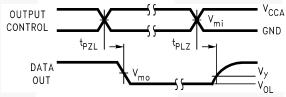


Test	Switch
t _{PLH} ,t _{PHL}	Open
t _{PLZ} ,t _{PZL}	$V_{CCO} \cdot 2$ at $V_{CCO} = 3.3 \pm 0.3$ V, 2.5 V ± 0.2 V, 1.8 V ± 0.15 V, 1.5 V ± 0.1 V, 1.2 V ± 0.1 V
t _{PHZ} ,t _{PZH}	GND

Table 1. AC Load Table

V _{cco}	CL	R _L	Rtr1
1.2 V ± 0.1 V	15 pF	2 kΩ	2 kΩ
1.5 V ± 0.1 V	15 pF	2 kΩ	2 kΩ
1.8 V ± 0.15 V	30 pF	500 kΩ	500 kΩ
2.5 V ± 0.2 V	30 pF	500 kΩ	500 kΩ
$3.3 \text{ V} \pm 0.3 \text{ V}$	30 pF	500 kΩ	500 kΩ





Note:

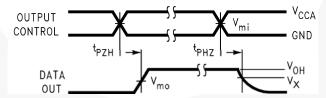
7. Input $t_R = t_F = 2.0 \text{ ns}$, 10% to 90%

Figure 3. Waveform for Inverting and Non-Inverting Functions

Note:

8. Input $t_R=t_F=2.0$ ns, 10% to 90%

Figure 4. 3-State Output Low Enable and Disable for Low Voltage Logic



Note:

9. Input $t_R=t_F=2.0$ ns, 10% to 90%

Figure 5. 3-State Output High Enable and Disable for Low Voltage Logic

Symbol	V _{cc}				
	3.3 V ± 0.3 V	2.5 V ± 0.2 V	1.8 V ± 0.15 V	1.5 V ± 0.1 V	1.2 V ± 0.1 V
V_{MI}	V _{CCI} /2	V _{CCI} /2	V _{CCI} /2	V _{CCI} /2	V _{CCI} /2
V_{MO}	V _{cco} /2	V _{CCO} /2	V _{CCO} /2	V _{CCO} /2	V _{CCO} /2
V_X	V _{OH} - 0.3 V	V _{OH} – 0.15 V	V _{OH} – 0.15 V	V _{OH} – 0.1 V	V _{OH} – 0.1 V
V_{Y}	V _{OL} + 0.3 V	V _{OL} + 0.15 V	V _{OL} + 0.15 V	V _{OL} + 0.1 V	V _{OL} + 0.1 V

Note

Functional Description

Power-Up/Power-Down Sequencing

FXL translators offer an advantage in that either V_{CC} may be powered up first. This benefit derives from the chip design. When either V_{CC} is at 0 V, outputs are in a High-impedance state. The control inputs (T/R and OE) are designed to track the V_{CCA} supply. A pull-up resistor tying OE to V_{CCA} should be used to ensure that bus contention, excessive currents, or oscillations do not occur during power-up/power-down. The size of the pull-up resistor is based upon the current-sinking capability of the OE driver.

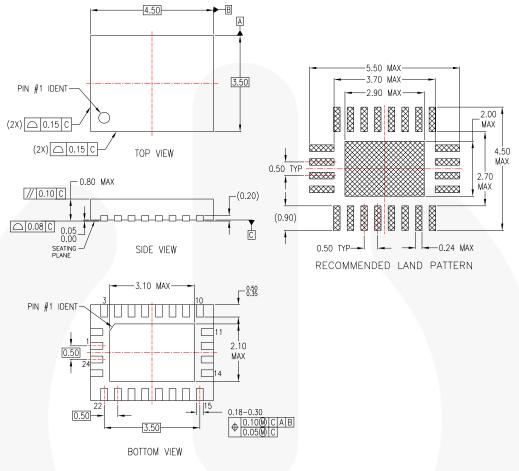
The recommended power-up sequence is:

- Apply power to either V_{CC}.
- Apply power to the T/R input (logic HIGH for A-to-B operation; logic LOW for B-to-A operation) and to the respective data inputs (A port or B port). This may occur at the same time as step 1.
- 3. Apply power to the other V_{CC} .
- 4. Drive the OE input LOW to enable the device.

The recommended power-down sequence is:

- Drive OE input HIGH to disable the device.
- 2. Remove power from either V_{CC}.
- 3. Remove power from the other V_{CC} .

Physical Dimensions



NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-220, VARIATION WFSD-2 FOR DIMENSIONS ONLY. PIN NUMBERING DOES NOT COMPLY.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

MLP24Brev4

Figure 6. 24-Pin Molded Leadless Package (MLP), JEDEC MO-220, 3.5 x 4.5 mm

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